

1. Features

- Typical 1dB bandwidth of 20.5 MHz
- High attenuation
- Single Ended Operation
- Dual In-line Package (DIP)

RoHS Compliant

Tested by SGS Testing Korea

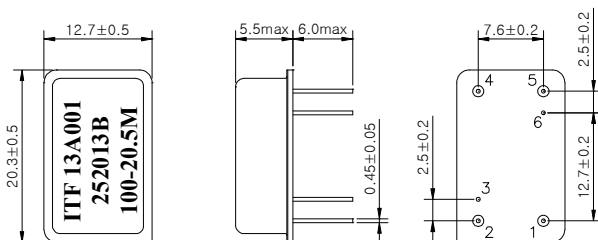
2. Electrical Specifications

Source and Load Impedance = 50Ω

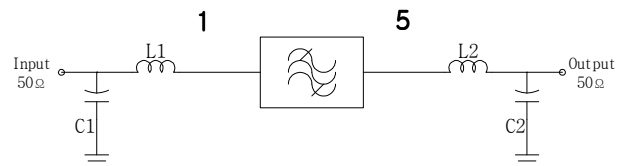
Operating Temperature : -30 °C ~ + 80 °C		Minimum	Typical	Maximum
Center Frequency (fo)	MHz	-	100.0	-
Insertion Loss	dB	-	22.0	23.5
1dB Bandwidth	MHz	20.35	20.56	-
3dB Bandwidth	MHz	-	20.89	-
40dB Bandwidth	MHz	-	22.31	22.45
Amplitude Ripple (fo±9.508MHz)	dB	-	0.55	1.0
Group Delay Variation (fo±9.508MHz)	nsec	-	40	80
Absolute Delay	usec	-	2.05	-
Ultimate Rejection	dB	50	55	-
Temperature Coefficient of Frequency	ppm/°C	-	-72	-

Room Temperature : + 25 °C		Minimum	Typical	Maximum
Insertion Loss	dB	-	22.0	23.5
Amplitude Ripple (fo ± 9.905 MHz)	dB	-	0.55	1.0
Group Delay Variation (fo ± 9.905 MHz)	nsec	-	40	80

D2012 Package Dimension



Matching Schematic



L1 = 100nH, L2 = 82nH, C1 = C2 = 22pF

Dimensions shown are nominal in millimeters

Base : Fe(SPCC), Au plating over Ni plated
Cap : Cu & Cr Alloy, Ni Plated
Termination : Kovar, Au Plated

Pin Configuration

Pin Configuration			
Input	1	Ground	2,4
Output	5	Others	Ground

3. Typical Performance (at +25°C)

